



NOTES:

1. Dimensions are in inches.
2. Component Side shown.
3. J52 mounts with body on Solder side and pins on Component Side.
4. No components or traces (except CHASSIS GND) in keep-out area.
5. See drawing 'PCB OUTLINE, MEP BOX' for details of board corners and skewer rod cutouts.

A	97-08-11	First release.
B	97-09-02	Change J18 from KA53; revise board mounting holes; remove pins from J3 and J7.
C	97-09-10	Move end skewer holes from other side of center; move J2 & J7 closer to corner.
D	97-09-12	Move J2 0.500 right; move J3 0.200 left.
E	97-09-26	Move J7 down 1.548; move J2 from top edge.
F	97-09-29	Move J2, J7, J18 per HDH fax of 970918.

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PCB Outline,
MEP DPU EM

8100-V4